



PCB LOGO
Texas Instruments

ZZ1
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

PCB Number: TIDA-00827
PCB Rev: E1

PCB LOGO
Pb-Free Symbol

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Orderable: N/A	Designed for: Public Release	Mod. Date: 11/20/2015
TID #: TIDA-00827	Project Title: Integrated Sensored BLDC Motor Controller	
Number: TIDA-00827	Rev: E1	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: [No Variations]	Sheet: 2 of 3
Drawn By:	File: TIDA-00827.SchDoc	Size: A3
Engineer: Nick Oborny	Contact: http://www.ti.com/support	



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